

PATENT ASSIGNMENT COVER SHEET

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Stylesheet Version v1.2

EPAS ID: PAT7818061

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
HOJIN JANG	09/17/2020
JONGIN KIM	09/17/2020
JONGHYUN PARK	09/17/2020
JANGHYUN SON	09/17/2020
RECEIVING PARTY DATA	
Name:	HP PRINTING KOREA CO., LTD.
Street Address:	129 SAMSUNG-RO, YEONGTONG-GUSUWON-SI
City:	GYENOGGI-DO
State/Country:	KOREA, REPUBLIC OF
Postal Code:	443-742
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	18023665
CORRESPONDENCE DATA	
Fax Number:	(202)672-5399
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Phone:	2026725300
Email:	IPdocketing@Foley.com,mloopescarvalho@Foley.com
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Address Line 1:	3000 K STREET N.W.
Address Line 2:	SUITE 600
Address Line 4:	WASHINGTON, D.C. 20007
ATTORNEY DOCKET NUMBER:	86226564
NAME OF SUBMITTER:	MARIA LOPES-CARVALHO
SIGNATURE:	/Maria Lopes-Carvalho/
DATE SIGNED:	02/27/2023
	This document serves as an Oath/Declaration (37 CFR 1.63).
Total Attachments: 4	

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source=86226564_Executed Assignment - Inventors#page2.tif
source=86226564_Executed Assignment - Inventors#page3.tif
source=86226564_Executed Assignment - Inventors#page4.tif

HP Inc.
3590 E. Harmony Road
Mail Stop 35
Fort Collins, Colorado 80528

RECORD ID: 88924581

ASSIGNMENT OF PATENT APPLICATION

I, the undersigned, to the extent not already owned by or assigned and transferred to HP PRINTING KOREA CO., LTD., according to applicable law by virtue of my employment or agreement related thereto, for good and valuable consideration, the receipt of which is hereby acknowledged, agree to assign and transfer and hereby assign and transfer to

HP PRINTING KOREA CO., LTD., a Korean company, having a principal business address in 152 Pangyojeok-ro, Bundang-gu, Seongnam-si, Gyeonggi-do, REPUBLIC OF KOREA, (hereinafter "HP PK").

its successors, and its assigns, my entire right, title, and interest, including all rights of priority, in, to, and under an application for patent entitled (English-language title in parentheses if said application for patent is in another language):

Title: 현상제 공급부의 풍금구 셔터를 밀폐하는 구조를 갖는 현상기
(developing device with sealing structure to seal shutter for developer inlet of developer supply portion)

Filing Date: September 23, 2020 Application No.: 10-2020-0122969 Patent Office: KR

the subject matter, including any and all inventions, improvements, and discoveries, set forth in said application for patent (as used herein "patent" refers to any form of intellectual property protection including, without limitation, invention rights, utility patent rights, design rights, and utility model rights) (hereinafter "Inventions"); any and all existing and future applications for patent of any country or region or under any international agreement for any of said Inventions (including, without limitation, said application for patent, any and all applications for patent directly or indirectly claiming priority to or benefit of any application for patent for any of said Inventions, any and all applications for patent from which any application for patent for any of said Inventions directly or indirectly claims priority or benefit, and any and all continuation applications of, continuation-in-part applications (hereinafter "CIPs") of, divisional applications of, national-phase applications of, regional-phase applications of, renewals of, and substitutes for any application for patent for any of said Inventions) (hereinafter "Applications for Patent"); any and all patents which may be granted on or as a result of said Applications for Patent (hereinafter "Patents"); and any and all reissues, reexaminations, and extensions of said Applications for Patent or said Patents.

I HEREBY represent that I convey my full rights in all countries and regions and under all international agreements to the entire right, title, and interest herein assigned and transferred, and that I have not executed and will not execute any agreement in conflict herewith;

AND I HEREBY authorize HP PK, its successors, its assigns, its nominees, and its legal representatives to file said Applications for Patent in its name or in my name in any country or region or under any international agreement, and further authorize HP PK, its successors, its assigns, its nominees, and its legal representatives to insert the filing date, application number, and patent office of said application for patent, now identified by the Record ID and title set forth above, when known to them;

AND I HEREBY authorize and request the officials of all countries and regions and under all international agreements whose duty it is to issue patents, to issue to HP PK, its successors, or its assigns, as assignee of my entire right, title, and interest, said Patents, in accordance with the terms of this assignment and transfer;

AND I HEREBY covenant and agree that I will, each time a request is made, and without undue delay, execute and deliver all such papers as may be necessary or desirable to perfect the title in said Inventions, Applications for Patent, and Patents, to HP PK, its successors, or its assigns; communicate to HP PK, its successors, its assigns, its nominees, or its legal representatives, all known facts respecting said Inventions, Applications for Patent, and Patents; testify in any legal or administrative proceedings and sign all lawful papers (including, without limitation, divisional applications, continuation applications, CIPs, and reissue applications) relating to said Inventions, Applications for Patent, and Patents; and make all rightful oaths and declarations and generally to do everything possible to aid HP PK, its successors, its assigns, its nominees, and its legal representatives to obtain, maintain, and enforce, for its or their own benefit, proper intellectual property protection for said Inventions, Applications for Patent, and Patents, provided the expenses which may be incurred by me in lending such cooperation and assistance are paid by HP PK, its successors, its assigns, its nominees, or its legal representatives.

IN WITNESS WHEREOF, I hereunto set my hand and seal:

Hojin Jang
Inventor's Signature

19 09 2020
Day Month Year

Hojin JANG
Inventor's Legal Name

Rev 2/2020

PATENT
REEL: 062818 FRAME: 0719

HP Inc.
3390 E. Harmony Road
Mail Stop 35
Fort Collins, Colorado 80528

RECORD ID: 85924561

ASSIGNMENT OF PATENT APPLICATION

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{developing device with sealing structure to seal shutter for developer inlet of developer supply portion}

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IN WITNESS WHEREOF, I hereunto set my hand and seal:

Jongin KIM
Inventor's Signature

19 09 2020
Day Month Year

Jongin KIM
Inventor's Legal Name

Rev 51

PATENT
REEL: 062818 FRAME: 0720

HP Inc.
3380 E. Harmony Road
Mail Stop 35
Fort Collins, Colorado 80528

RECORD ID: 86924561

ASSIGNMENT OF PATENT APPLICATION

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Title: (developing device with sealing structure to seal shutter for developer inlet of developer supply portion)

Filing Date: September 23, 2020 Application No.: 10-2020-0122969 Patent Office: KR

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IN WITNESS WHEREOF, I hereunto set my hand and seal:

Jonghyun Park
Inventor's Signature

17 09 2020
Day Month Year

Jonghyun PARK
Inventor's Legal Name

Rev 8/2000

PATENT
REEL: 062818 FRAME: 0721

HP Inc.
3350 E. Harmony Road
Mail Stop 35
Fort Collins, Colorado 80528

RECORD ID: 86924561

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IN WITNESS WHEREOF, I hereunto set my hand and seal:

Janghyun SOU
Inventor's Signature

11 09 2020
Day Month Year

Janghyun SOU
Inventor's Legal Name